

Product specifications contained herein may be changed without prior notice. It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.

AND5BA

GaN Ultra Bright Blue Light Emission Surface Mount Package

Features

- · Small package size with dome lens
- RoHS Compliant
- 3.2 (I) x 2.4 (w) x 2.6 (h) size
- · Suitable for REFLOW soldering
- · Recommended Forward Current: 10 mA

Maximum Ratings ($T_a = 25$ °C)

Characteristics	Symbol	Rating	Unit
Forward Current	IF	30	mA
Reverse Voltage	V _R	4	V
Power Dissipation	P _D	100	mW
Operating Temperature Range	T _{Opr}	-30 to 85	°C
Storage Temperature Range	T _{Stg}	-30to 90	°C

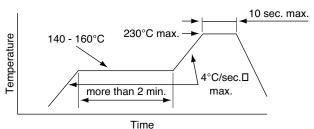
Electro-Optical Characteristics ($T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V _F	I _F = 20 mA	_	3.8	4.5	V
Reverse Current	I _R	V _R = 4 V	_	_	100	μΑ
Luminous Intensity	I _V	I _F = 20 mA	90	112	-	mcd
Peak Emission Wavelength	l _P	I _F = 20 mA	_	430	-	nm
Spectral Line Half Width	ΔΙ	I _F = 20 mA	_	65	=	nm
Dominant Wavelength	ld	I _F = 20 mA	_	450	_	nm
Full Viewing Angle	θ	I _V = 1/2 Peak	_	30	_	degree

Precaution

Please be careful of the following:

- Manual soldering: maximum temperature of iron tip: 260°C max.
 Soldering time: within 5 sec. per solder-land
 Soldering portion of lead: up to 1.6 mm from the body of the device
- 2. Reflow solder: recommended condition is as follows:



 Absolute secure counter measures against static electricity and surge should be taken when handling these products. It is recommended to use wrist band or antistatic gloves when handling these LEDs.

The following soldering patterns are ☐ recommended for reflow soldering

